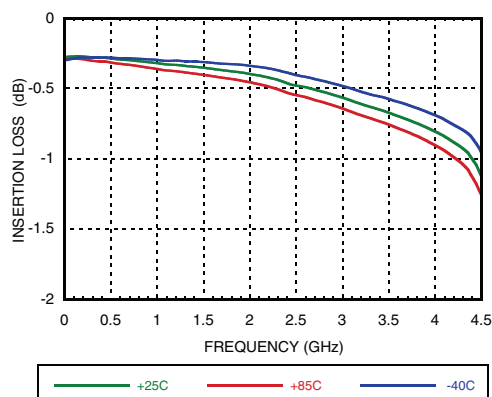
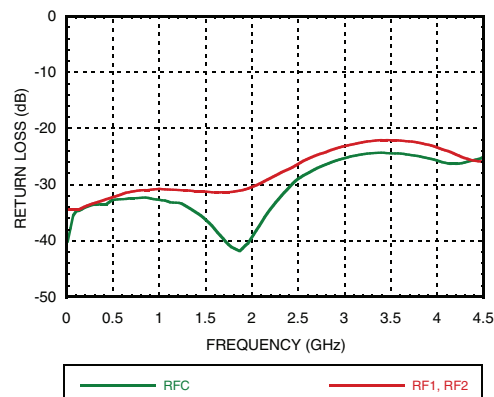
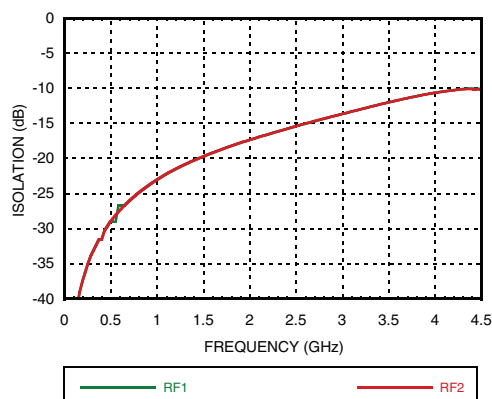
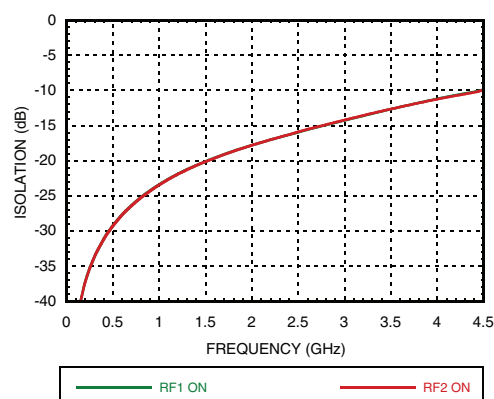
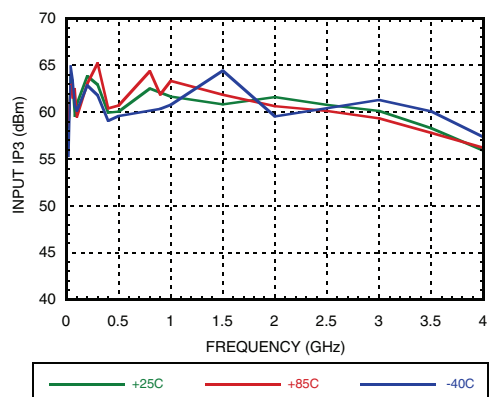
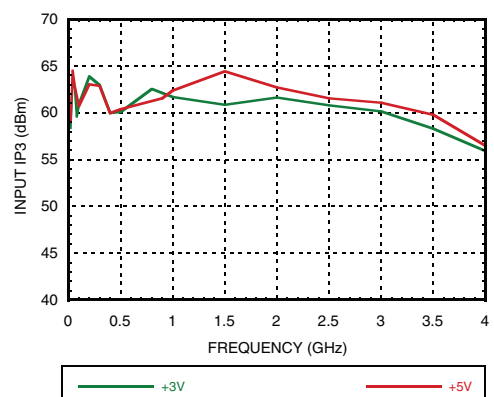
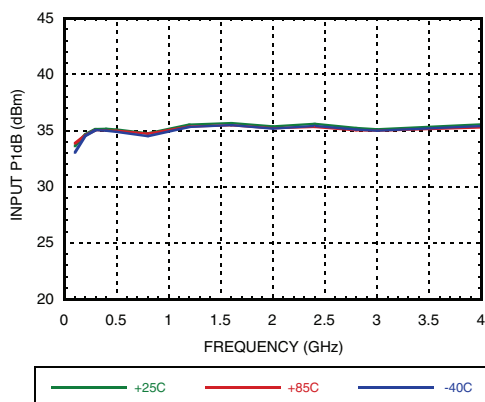
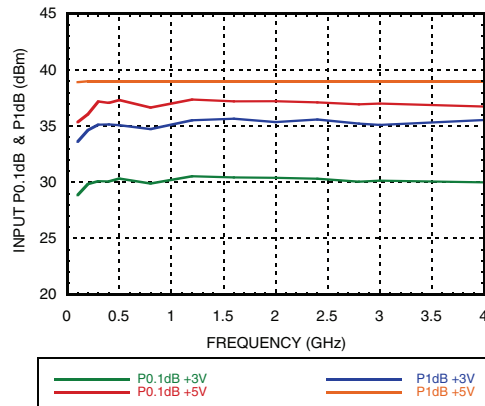


Insertion Loss

Return Loss

Isolation Between Ports RFC & RF1 / RF2

Isolation Between Ports RF1 & RF2

Input IP3 vs. Temperature, Vctl = 0/+3V

Input IP3 vs. Vctl


Input P1dB vs. Temperature, Vctl = 0/+3V

Compression vs. Vctl

Truth Table

| Control Input | | Signal Path | |
|---------------|------|-------------|------------|
| A | B | RFC to RF1 | RFC to RF2 |
| Low | High | On | Off |
| High | Low | Off | On |

Control Voltages

| State | Bias Condition |
|-------|--|
| Low | 0 to 0.2 Vdc @ 1 μ A Typical |
| High | +3 Vdc @ 0.5 μ A Typical to +5 Vdc @ 1 μ A Typical (± 0.2 Vdc) |

Absolute Maximum Ratings

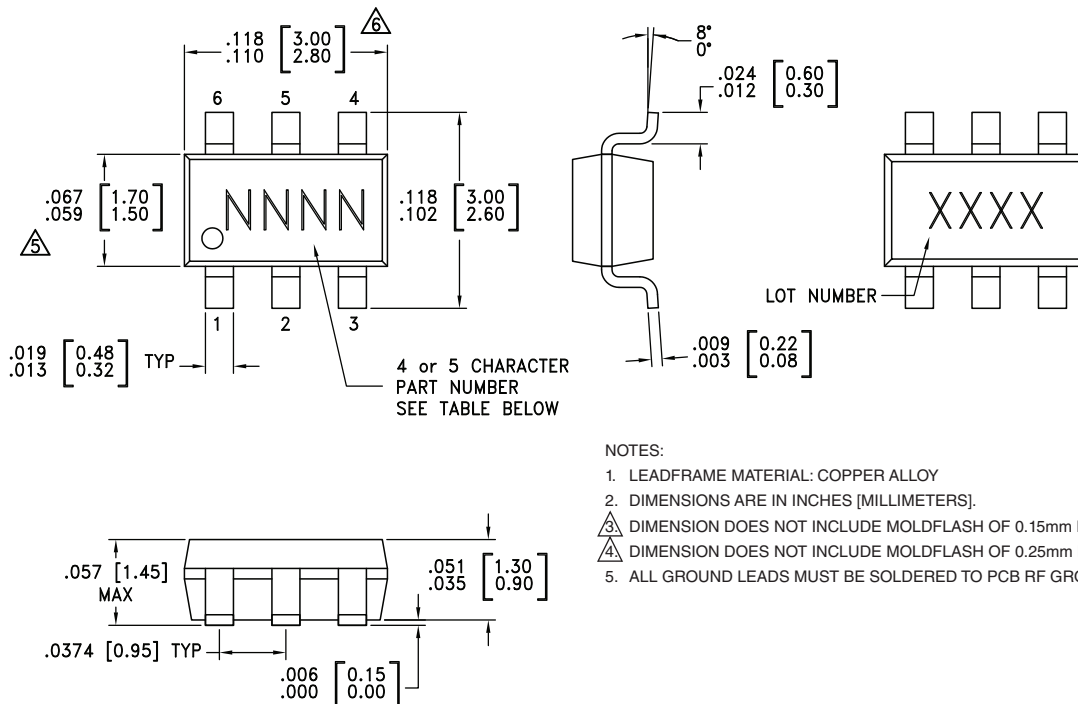
| | |
|--|-----------------|
| RF Input Power (Vctl = 0/+5V) | +39 dBm |
| Control Voltage Range (A & B) | -0.2 to +12 Vdc |
| Hot Switch Power Level (Vctl = 0/+5V) | +39 dBm |
| Channel Temperature | 150 °C |
| Continuous Pdiss (T= 85 °C) (derate 8.85 mW/ °C above 85°C) | 0.574 W |
| Thermal Resistance | 113.3 °C/W |
| Storage Temperature | -65 to +150 °C |
| Operating Temperature | -40 to +85 °C |
| ESD Sensitivity (HBM) | Class 1B |

DC blocks are required at ports RFC, RF1 and RF2.



ELECTROSTATIC SENSITIVE DEVICE
OBSERVE HANDLING PRECAUTIONS

Outline Drawing



NOTES:

1. LEADFRAME MATERIAL: COPPER ALLOY
2. DIMENSIONS ARE IN INCHES [MILLIMETERS].
3. DIMENSION DOES NOT INCLUDE MOLDFLASH OF 0.15mm PER SIDE.
4. DIMENSION DOES NOT INCLUDE MOLDFLASH OF 0.25mm PER SIDE.
5. ALL GROUND LEADS MUST BE SOLDERED TO PCB RF GROUND.

Package Information

| Part Number | Package Body Material | Lead Finish | MSL Rating | Package Marking ^[3] |
|-------------|--|---------------|---------------------|--------------------------------|
| HMC544A | Low Stress Injection Molded Plastic | Sn/Pb Solder | MSL1 ^[1] | 544A XXXX |
| HMC544AE | RoHS-compliant Low Stress Injection Molded Plastic | 100% matte Sn | MSL1 ^[2] | 544AE XXXX |

[1] Max peak reflow temperature of 235 °C

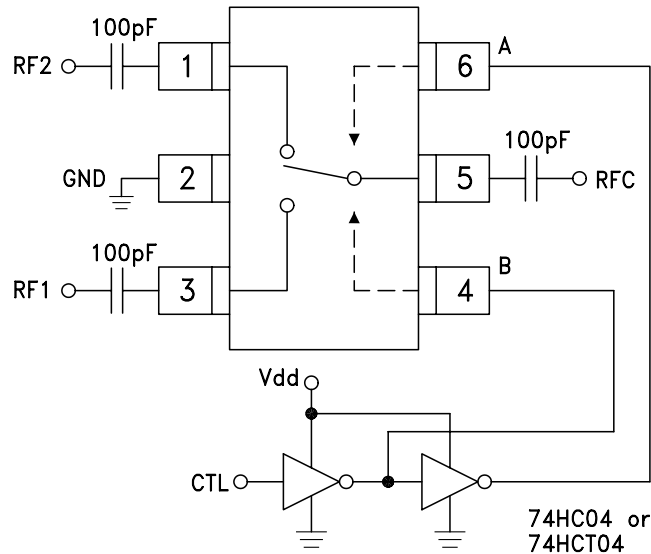
[2] Max peak reflow temperature of 260 °C

[3] 4-Digit lot number XXXX

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Typical Application Circuit

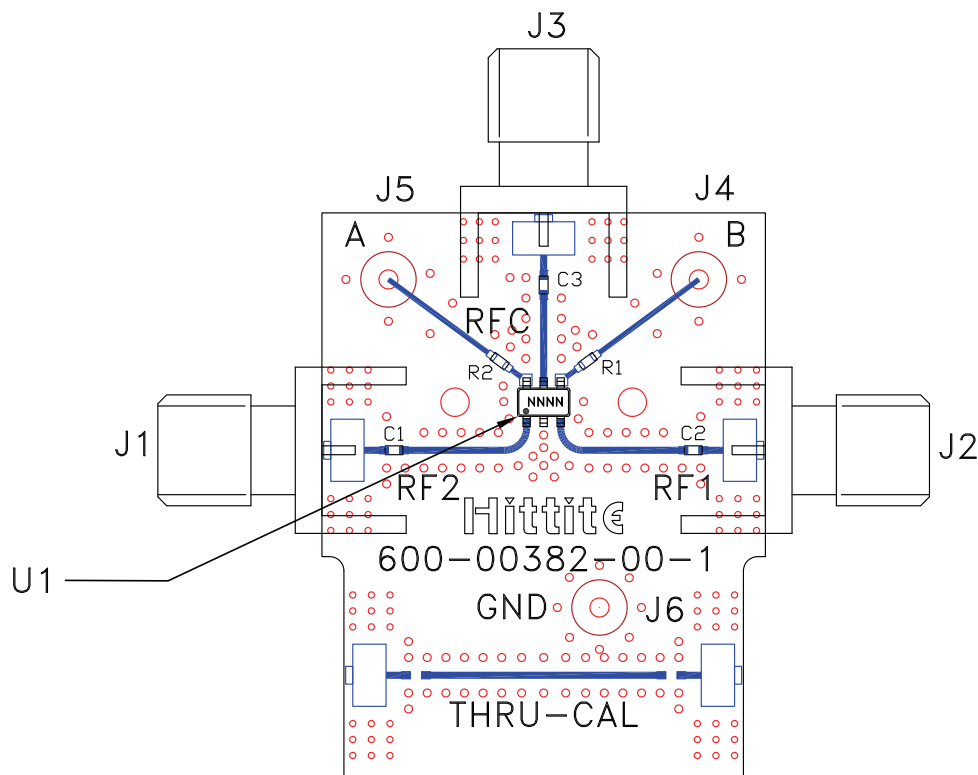


Notes:

1. Set logic gate Vdd = +3V to +5V and use HCT series logic to provide a TTL driver interface.
2. Control inputs A/B can be driven directly with CMOS logic (HC) with Vdd of +3V to +5V applied to the CMOS logic gates.
3. DC Blocking capacitors are required for each RF port as shown. Capacitor value determines lowest frequency of operation.

Pin Descriptions

| Pin Number | Function | Description | Interface Schematic |
|------------|---------------|---|---------------------|
| 1, 3, 5 | RF2, RF1, RFC | These pins are DC coupled and matched to 50 Ohms. Blocking capacitors are required. | |
| 2 | GND | This pin must be connected to RF/DC ground. | |
| 4 | B | See truth and control voltage tables. | |
| 6 | A | See truth and control voltage tables. | |

Evaluation Circuit Board

List of Materials for Evaluation PCB EVAL01-HMC544A [1]

| Item | Description |
|---------|-------------------------------|
| J1 - J3 | PCB Mount SMA RF Connector |
| J4 - J6 | DC Pin |
| C1 - C2 | 330 pF capacitor, 0402 Pkg. |
| R1 - R2 | 1 KOhm resistor, 0402 Pkg. |
| U1 | HMC544A / 544AE SPDT Switch |
| PCB [2] | 600-00382-00-1 Evaluation PCB |

[1] Reference this number when ordering complete evaluation PCB

[2] Circuit Board Material: Rogers 4350

The circuit board used in the application should be generated with proper RF circuit design techniques. Signal lines at the RF port should have 50 Ohm impedance and the package ground leads should be connected directly to the ground plane similar to that shown above. The evaluation circuit board shown above is available from Hittite Microwave Corporation upon request.